

To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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RENESAS

SILICON POWER TRANSISTOR NTC1862

HIGH SPEED HIGH VOLTAGE SWITCHING NPN SILICON TRIPLE DIFFUSED TRANSISTOR

Industrial Use

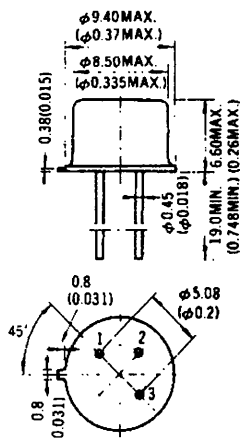
DESCRIPTION

Suitable for switching regulator, DC-DC converter and ultrasonic appliance applications.

FEATURES

- High speed switching.
- Low collector saturation voltage.
- Specified of reverse biased S.O.A. with inductive loads.

PACKAGE DIMENSIONS in millimeters (inches)



1. Emitter
2. Base
3. Collector (Case)

EIAJ : TC-5, TB-5B
JEDEC : TO-205MD (TO-39)
IPC : C4, B4B

ABSOLUTE MAXIMUM RATINGS

Maximum Voltages and Currents ($T_a = 25^\circ\text{C}$)

Collector to Emitter Voltage	V_{CEX}	500	V
Collector to Emitter Sustaining Voltage	$V_{CEO(SUS)}$	400	V
Collector to Emitter Sustaining Voltage	$V_{CEX(SUS)}$	450	V
Emitter to Base Voltage	V_{EBO}	7.0	V
Continuous Collector Current	$I_C(DC)$	2.0	A
Peak Collector Current*	$I_C(pulse)$	4.0	A
Continuous Base Current	$I_B(DC)$	1.0	A
Peak Base Current*	$I_B(pulse)$	2.0	A

Maximum Power Dissipations

Total Power Dissipation	$P_T(T_c=25^\circ\text{C})$	15	W
Total Power Dissipation	$P_T(T_c=100^\circ\text{C})$	8.6	W
Total Power Dissipation	$P_T(T_a=25^\circ\text{C})$	1.0	W

Maximum Temperatures

Junction Temperature	T_j	200	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +200	$^\circ\text{C}$
Lead Temperature	T_L	260	$^\circ\text{C}$
1/8 inch from case for 10 seconds			

Thermal Resistances

Junction to Case	$R_{th(j-c)}$	11.7	$^\circ\text{C/W}$
Junction to Ambient	$R_{th(j-a)}$	175	$^\circ\text{C/W}$

* Pulsed $PW \leq 300 \mu\text{s}$, duty cycle $\leq 10\%$

Nippon Electric Co., Ltd.

ELECTRICAL CHARACTERISTICS (Ta = 25°C unless otherwise noted)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Collector to Emitter Sustaining Voltage	VCEO(SUS)	400			V	Table 1. IC = 0.5A, IB1 = 0.1A, L = 1mH
	VCEX(SUS)1	450			V	Table 1. IC = 0.5A, IB1 = -IB2 = 0.1A, Vclamp = Rated VCEX, Ta = 125°C
	VCEX(SUS)2	400			V	Table 1. IC = 1A, IB1 = 0.2A, IB2 = -0.1A, Vclamp = Rated VCEX, Ta = 125°C
Collector Cutoff Current	ICER			200	μA	VCE = 500V, RBE = 500Ω, Ta = 125°C
	ICEX			10	μA	VCE = 500V, VBE(OFF) = 1.5V
	ICEX			200	μA	VCE = 500V, VBE(OFF) = 1.5V, Ta = 125°C
Emitter Cutoff Current	IEBO			1.0	μA	VEB = 7.0V, IC = 0
Second Breakdown Collector Current	IS/B	0.75			A	t = 1.0 s, VCE = 20V, Tc = 25°C
Second Breakdown Energy	ES/B	5			μJ	IC = 0.5A, IB1 = 0.1A, VBE(OFF) = 5V
DC Current Gain	hFE1	20		100		VCE = 5V, IC = 0.1A **
	hFE2	10				VCE = 5V, IC = 0.5A **
Collector Saturation Voltage	VCE(sat)			1.0	V	IC = 0.5A, IB = 0.1A **
	VCE(sat)			1.5	V	IC = 0.5A, IB = 0.1A, Ta = 125°C **
Base Saturation Voltage	VBE(sat)			1.5	V	IC = 0.5A, IB = 0.1A **
	VBE(sat)			1.5	V	IC = 0.5A, IB = 0.1A, Ta = 125°C **
Gain Bandwidth Product	fT	20			MHz	VCE = 10V, IC = 50mA, f0 = 3.0MHz, Tc = 25°C
Output Capacitance	Cob			60	pF	VCB = 10V, f0 = 1.0 MHz
Delay Time	td			0.1	μs	Resistive Load (Table 1.)
Rise Time	tr			0.9	μs	
	tr			2.7	μs	Ta = 125°C IC = 0.5A, IB1 = -IB2 = 0.1A
Storage Time	tstg			2.5	μs	RL = 300Ω, VCC ≈ 150V
	tstg			5.0	μs	Ta = 125°C PW ≈ 50μs, duty cycle ≤ 2%
Fall Time	tf			0.7	μs	
	tf			2.8	μs	Ta = 125°C

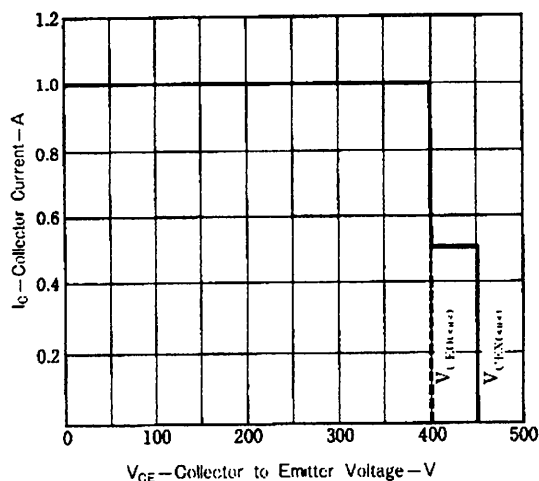
** PW ≤ 350 μs, duty cycle ≤ 2%

TABLE 1. – TEST CONDITIONS FOR DYNAMIC PERFORMANCE

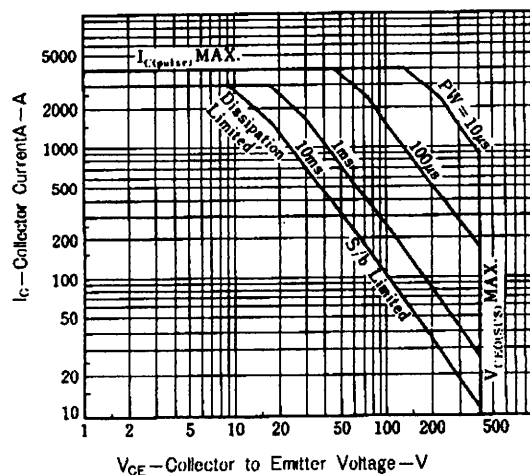
INPUT CONDITIONS	VCEO (SUS)	VCEX (SUS)	ES/B	RESISTIVE SWITCHING
CIRCUIT VALUES	Lcoil = 1 mH, VCC = 10V Rcoil = 1.0Ω Vclamp (Unclamped)	Lcoil = 180 μH, VCC = 20V Rcoil = 0.05Ω Vclamp = Rated VCEX Value	Lcoil = 40 μH, VCC = 10V Rcoil = 0.05Ω, RBB2 = 50Ω Vclamp (Unclamped)	RL = 300Ω VCC ≈ 150V
TEST CIRCUITS				RESISTIVE TEST CIRCUIT

TYPICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

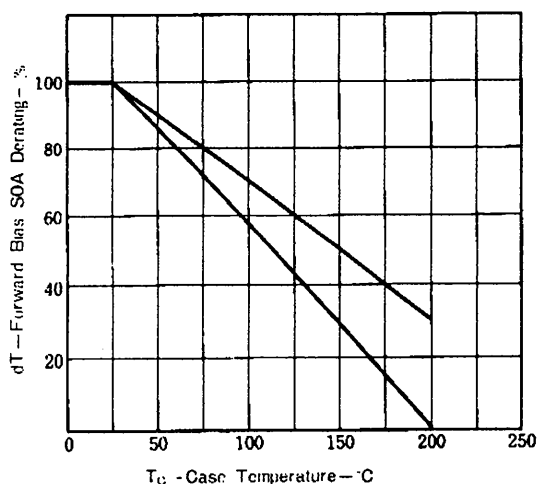
REVERSE BIAS SAFE OPERATING AREA



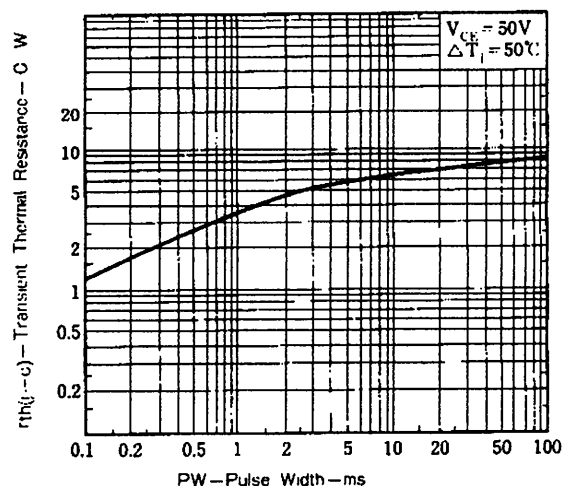
FORWARD BIAS SAFE OPERATING AREAS



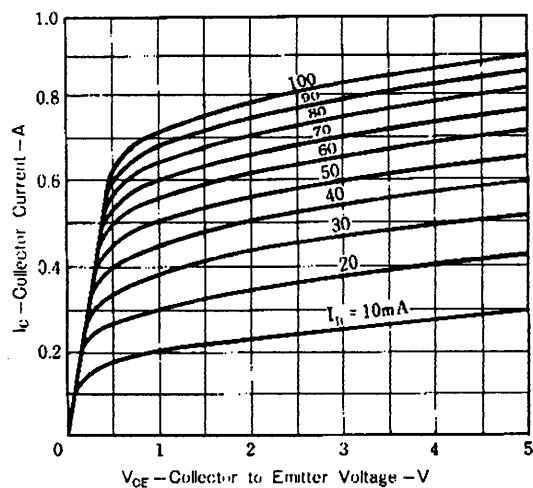
DERATING CURVE OF FORWARD BIAS SAFE OPERATING AREA



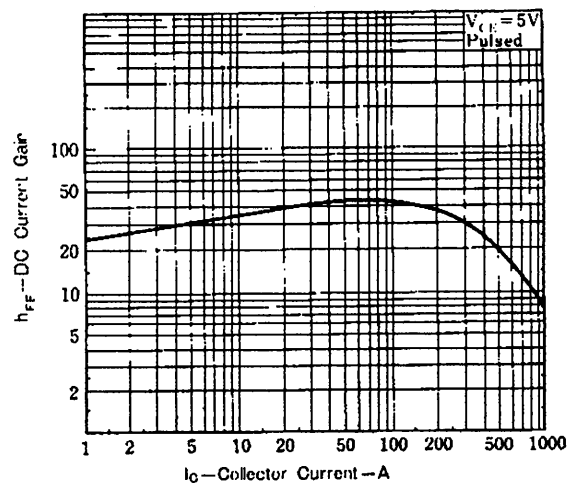
TRANSIENT THERMAL RESISTANCE

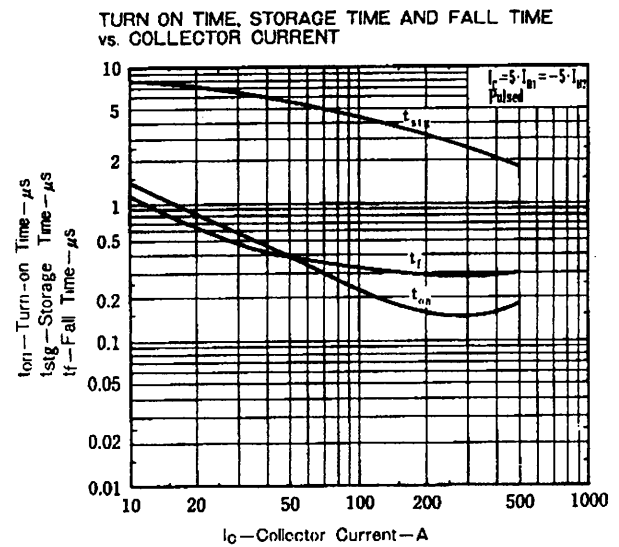
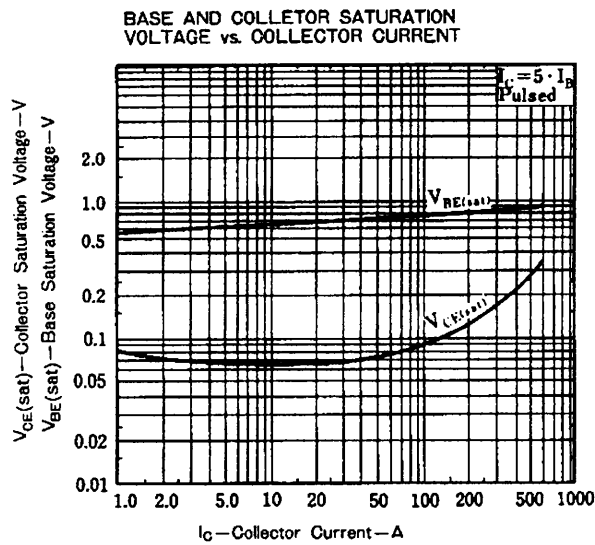


COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



DC CURRENT GAIN vs. COLLECTOR CURRENT





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